



1 NOTE:
020122MR008 □ □ 23ZU

1. Selective plating
 'S1,-05u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 'S2,-Gold flash in contact area/
 100u" Min. Tin in solder area.
 'S3,-10u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 'S4,-15u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 'S5,-30u" Min. gold in contact area/
 100u" Min. Tin in solder area.
 'S6,-50u" Min. gold in contact area/
 100u" Min. Tin in solder area.

5				
4				
3	Shell	C2680H	—	NICK PLATED
2	Terminal	Pho.Bronze	—	Gold/Tin
1	Housing	LCP	BLACK	UL94V-0
NO. DESCRIPTION		MATERIAL	COLOR	REMARK

SUYIN
CONNECTOR

CUSTOMER COPY	TITLE:	USB Series A Type Dual Port Dip Type		
PART NO.	020122MR008SX23ZU			
PART NO. (OLD)	2522A-08GXT-W			
DRAWING NO.	D	020122MR008SX23ZU		
SCALE	4:1	UNIT	mm	A4

ECN (DCN) NO.	REV	DATE	DESCRIPTION	CHANGE	APPRO.	GENERAL TOLERANCE UNLESS OTHERWISE NOTED
	A	02/07/11	A1:增加塑膠偷料;A2,A3:修改鐵殼彈片			
			NEW			

Angle	±2°	DRAW	李儒平	02/07/08
30 ~	±0.50	DESIGN	李儒平	02/07/08
10 ~ 30	±0.30	CHECK	宋權哲	02/07/08
~ 10	±0.15	APPRO.	宋權哲	02/07/08